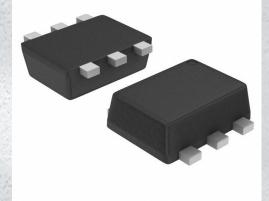


NTZS3151PT1H Datasheet

www.digi-electronics.com



DiGi Electronics Part Number	NTZS3151PT1H-DG
Manufacturer	onsemi
Manufacturer Product Number	NTZS3151PT1H
Description	MOSFET P-CH 20V 860MA SOT563-6
Detailed Description	P-Channel 20 V 860mA (Ta) 170mW (Ta) Surface Mo unt SOT-563
	Second States and a second

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Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
NTZS3151PT1H	onsemi
Series:	Product Status:
-	Obsolete
FET Type:	Technology:
P-Channel	MOSFET (Metal Oxide)
Drain to Source Voltage (Vdss):	Current - Continuous Drain (Id) @ 25°C:
20 V	860mA (Ta)
Drive Voltage (Max Rds On, Min Rds On):	Rds On (Max) @ ld, Vgs:
1.8V, 4.5V	150mOhm @ 950mA, 4.5V
Vgs(th) (Max) @ ld:	Gate Charge (Qg) (Max) @ Vgs:
1V @ 250μA	5.6 nC @ 4.5 V
Vgs (Max):	Input Capacitance (Ciss) (Max) @ Vds:
±8V	458 pF @ 16 V
FET Feature:	Power Dissipation (Max):
-	170mW (Ta)
Operating Temperature:	Mounting Type:
-55°C ~ 150°C (TJ)	Surface Mount
Supplier Device Package:	Package / Case:
SOT-563	SOT-563, SOT-666
Base Product Number:	
NTZS3151	

Environmental & Export classification

Moisture Sensitivity Level (MSL):	REACH Status:
1 (Unlimited)	REACH Unaffected
ECCN:	HTSUS:
EAR99	8541.21.0095

NTZS3151P

<u>MOSFET</u> – P-Channel, Small Signal, SOT-563

-20 V, -950 mA

Features

- Low R_{DS(on)} Improving System Efficiency
- Low Threshold Voltage
- Small Footprint 1.6 x 1.6 mm
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

- Load/Power Switches
- Battery Management
- Cell Phones, Digital Cameras, PDAs, Pagers, etc.

MAXIMUM RATINGS (T_J = 25° C unless otherwise noted.)

_					
Parameter		Symbol	Value	Unit	
Drain-to-Source Voltage			V _{DSS}	-20	V
Gate-to-Source Voltage			V _{GS}	±8.0	V
Continuous Drain Current	Steady	$T_A = 25^{\circ}C$	ID	-860	mA
(Note 1)	State	$T_A = 70^{\circ}C$	טי	-690	
Power Dissipation (Note 1)	Stead	Steady State		170	mW
Continuous Drain Current (Note 1)	t≤5s	$T_A = 25^{\circ}C$	I _D	-950	mA
	1 - 00	$T_A = 70^{\circ}C$	טי	-760	
Power Dissipation (Note 1)	t ≤ 5 s		P _D	210	mW
Pulsed Drain Current	t _p = 10 μs		I _{DM}	-4.0	А
Operating Junction and Storage Temperature		T _J , T _{STG}	–55 to 150	°C	
Source Current (Body Diode)		ls	-360	mA	
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)		ΤL	260	°C	

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Max	Unit
Junction-to-Ambient - Steady State (Note 1)	$R_{\theta JA}$	720	°C/W
Junction-to-Ambient – t \leq 5 s (Note 1)	$R_{\theta JA}$	600	

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Surface-mounted on FR4 board using 1 in. sq. pad size

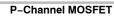
(Cu. area = 1.127 in. sq. [1 oz.] including traces).

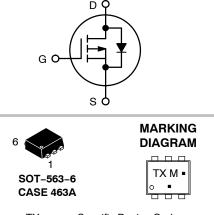


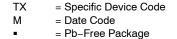
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http://onsemi.com

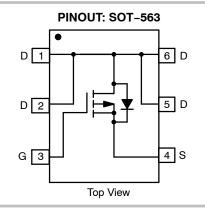
V _{(BR)DSS}	R _{DS(on)} Typ	I _D Max
	120 mΩ @ -4.5 V	
–20 V	144 mΩ @ −2.5 V	–950 mA
	195 mΩ @ –1.8 V	







(Note: Microdot may be in either location)



ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 4 of this data sheet.

NTZS3151PT1H onsemi MOSFET P-CH 20V 860MA SOT563-6

NTZS3151P

ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise noted.)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							•
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V, I _D =	= –250 μA	-20			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J				-13		mV/°C
Zero Gate Voltage Drain Current		$V_{GS} = 0 V$	$T_J = 25^{\circ}C$			-1.0	μA
	I _{DSS}	$V_{DS} = -20 V$	$T_J = 125^{\circ}C$			-5.0	
Gate-to-Source Leakage Current	I _{GSS}	V_{DS} = 0 V, V_{GS}	s = ±8.0 V			±100	nA
ON CHARACTERISTICS (Note 2)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D$	= –250 μA	-0.45		-1.0	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J				2.4		mV/°C
Drain-to-Source On Resistance		V_{GS} = -4.5 V, I _D	= -950 mA		120	150	mΩ
		V_{GS} = -4.5 V, I _D	= -770 mA		112	142	
	R _{DS(on)}	V _{GS} = -2.5 V, I _D	= -670 mA		144	200	
		V _{GS} = -1.8 V, I _D	= -200 mA		195	240	1
Forward Transconductance	g fs	V _{DS} = -10 V, I _D = -810 mA			3.1		S
CHARGES AND CAPACITANCES							
Input Capacitance	C _{ISS}	$V_{GS} = 0 V, f = 1.0 MHz, V_{DS} = -16 V$			458		pF
Output Capacitance	C _{OSS}				61		1
Reverse Transfer Capacitance	C _{RSS}				38		
Total Gate Charge	Q _{G(TOT)}				5.6		nC
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = -4.5 V, V _I I _D = -770	_{DS} = -10 V;		0.6		
Gate-to-Source Charge	Q _{GS}	$I_D = -770$	ЛПА		0.9		1
Gate-to-Drain Charge	Q _{GD}				1.2		
SWITCHING CHARACTERISTICS (Note	e 3)						•
Turn-On Delay Time	t _{d(ON)}	V_{GS} = -4.5 V, V_{DD} = -10 V, I_{D} = -950 mA, R_{G} = 6.0 Ω			5.0		ns
Rise Time	t _r				12		
Turn-Off Delay Time	t _{d(OFF)}				23.7		1
Fall Time	t _f				18		
DRAIN-SOURCE DIODE CHARACTER	ISTICS						•
Forward Diode Voltage		V _{GS} = 0 V,	$T_J = 25^{\circ}C$		-0.64	-0.9	V
	V _{SD}	$I_{\rm S} = -360 \rm{mA}$	T _J = 125°C		-0.5		

Reverse Recovery Time

Pulse Test: pulse width ≤ 300 µs, duty cycle ≤ 2%.
Switching characteristics are independent of operating junction temperatures.

t_{RR}

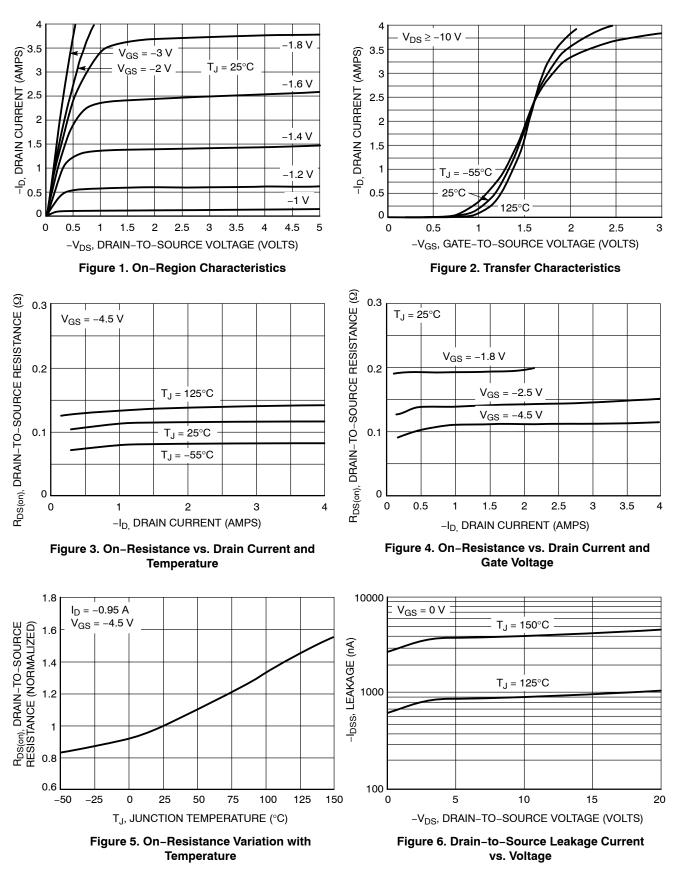
 $\label{eq:VGS} \begin{array}{l} V_{GS} = 0 \ V, \ dI_S/dt = 100 \ A/\mu s, \\ I_S = -360 \ mA \end{array}$

10.5

ns

NTZS3151PT1H onsemi MOSFET P-CH 20V 860MA SOT563-6

NTZS3151P



TYPICAL PERFORMANCE CURVES (T_J = 25°C unless otherwise noted)

NTZS3151P

TYPICAL PERFORMANCE CURVES (T_J = 25°C unless otherwise noted)

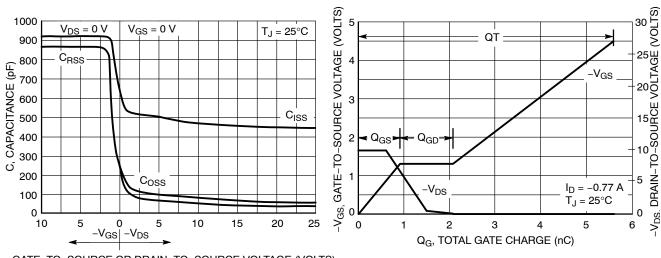




Figure 8. Gate-to-Source and Drain-to-Source Voltage vs. Total Charge

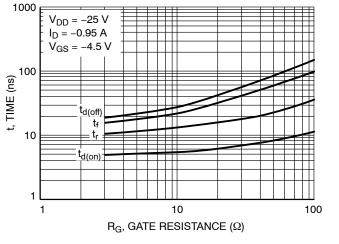


Figure 9. Resistive Switching Time Variation vs. Gate Resistance

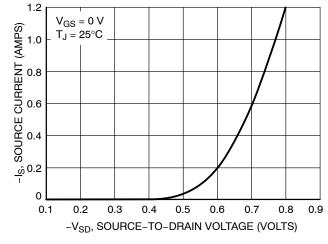


Figure 10. Diode Forward Voltage vs. Current

ORDERING INFORMATION

Device	Package	Shipping
NTZS3151PT1G	SOT–563 (Pb–Free)	4000 / Tape & Reel
NTZS3151PT1H	SOT-563 (Pb-Free)	4000 / Tape & Reel
NTZS3151PT5G	SOT-563 (Pb-Free)	8000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.



PACKAGE DIMENSIONS

SOT-563-6 1.60x1.20x0.55, 0.50P CASE 463A ISSUE J DATE 15 FEB 2024 NOTES: 1. DIMENSIONING AND TOLERANCING CONFORM TO ASME Y14.5-2018. 2 ALL DIMENSION ARE IN MILLIMETERS. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM 3 THICKNESS OF BASE MATERIAL. -A D MILLIMETERS А 6X L DIM В NDM. MIN MAX. 0.50 0.55 А 0.60 ļ 6 4 PIN b 0.17 0.22 0.27 F REFERENCE Н C 0.08 0.13 0.18 2 ັບ 1 3 D 1.50 1.60 1.70 П E 1.20 1.30 1.10 ⊨ 6X b C ⊕ 0.08∭ A B е 0.50 BSC е Н 1.50 1.60 1.70 TOP VIEW SIDE VIEW L 0.10 0.20 0.30 1.30 6X 0.45 0.30 1.80 STYLE 1: STYLE 2 STYLE 3 PIN 1. EMITTER 1 2. BASE 1 PIN 1. EMITTER 1 PIN 1. CATHODE 1 2. CATHODE 1 2. EMITTER 2 3. COLLECTOR 2 3. BASE 2 3. ANDDE/ANDDE 2 4. EMITTER 2 4. COLLECTOR 2 4. CATHODE 2 0.50 5. BASE 2 5. BASE 1 5. CATHODE 2 6. COLLECTOR 1 PITCH 6. COLLECTOR 1 6. ANDDE/ANDDE 1 RECOMMENDED MOUNTING FOOTPRINT* STYLE 6: PIN 1. CATHODE 2. ANODE FOR ADDITIONAL INFORMATION ON OUR Pb-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ON SEMICONDUCTOR SOLDERING AND MOUNTING TECHNIQUES REFERENCE STYLE 4: STYLE 5 1. CATHODE 2. CATHODE PIN 1. COLLECTOR PIN 2. COLLECTOR 3. BASE з. ANDDE 3. CATHODE 4. ANDDE 5. CATHODE 4. CATHODE 5. CATHODE 4. EMITTER MANUAL, SOLDERRM/D. 5, COLLECTOR 6. COLLECTOR 6. CATHODE 6. CATHODE GENERIC **MARKING DIAGRAM*** STYLE 7: STYLE 8 STYLE 9 PIN 1. CATHODE PIN 1. DRAIN PIN 1. SOURCE 1 2. ANDDE 3. CATHODE 4. CATHODE 2. DRAIN 2. GATE 1 XXM. 3. DRAIN 2 3. GATE 4. SOURCE 2 5. GATE 2 4. SOURCE 5. DRAIN 1 5. ANDDE 6. CATHODE 6. DRAIN 6. DRAIN 1 XX = Specific Device Code M = Month Code = Pb-Free Package STYLE 10: STYLE 11: *This information is generic. Please refer to PIN 1. CATHODE 1 PIN 1. EMITTER 2 device data sheet for actual part marking. 2. N/C 3. CATHODE 2 2. BASE 2 3. COLLECTOR 1 Pb-Free indicator, "G" or microdot "•", may 4. ANDDE 2 EMITTER 1 4. or may not be present. Some products may BASE 5. N/C 5. not follow the Generic Marking. 6. ANDDE 1 COLLECTOR 2 6. Electronic versions are uncontrolled except when accessed directly from the Document Repository. **DOCUMENT NUMBER:** 98AON11126D Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red. **DESCRIPTION:** SOT-563-6 1.60x1.20x0.55, 0.50P PAGE 1 OF 1

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